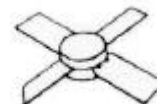


RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

Features

- 1025-1150 MHz
- GOLD METALLIZATION
- INFINITE VSWR CAPABILITY @ RATED CONDITIONS
- Pout = 4 W MINIMUM
- $G_p = 10$ dB
- COMMON BASE CONFIGURATION

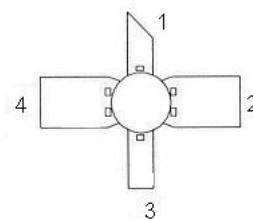


.280 4LSL (M115)
Epoxy Sealed

DESCRIPTION:

The MS2206 is a common base, silicon NPN microwave transistor designed for Class C driver applications under DME or IFF pulse conditions. This device is capable of withstanding an infinite load VSWR at any phase angle under rated conditions.

PIN CONNECTION



1. COLLECTOR 3. EMITTER
2. BASE 4. BASE

ABSOLUTE MAXIMUM RATINGS (Tcase = 25°C)

Symbol	Parameter	Value	Unit
P_{DISS}	Power Dissipation	7.5	W
V_{CE}	Collector-Emitter Bias Voltage	37	V
T_J	Junction Temperature	200	°C
I_C	Device Current	1.0	A
T_{STG}	Storage Temperature	-65 to +200	°C

Thermal Data

$R_{TH(J-C)}$	Junction-case Thermal Resistance*	35	°C/W
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MS2206

ELECTRICAL SPECIFICATIONS (Tcase = 25°C) STATIC

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
BV_{CBO}	I _C = 1 mA I _E = 0 mA	45	---	---	V
BV_{CEO}	I _C = 5 mA I _B = 0mA	20	---	---	V
BV_{EBO}	I _E = 1.0 mA I _C = 0 mA	3.5	---	---	V
I_{CES}	V _{CE} = 35 V	---	---	1.0	mA
HFE	V _{CE} = 5 V I _C = 100 mA	20	---	120	---

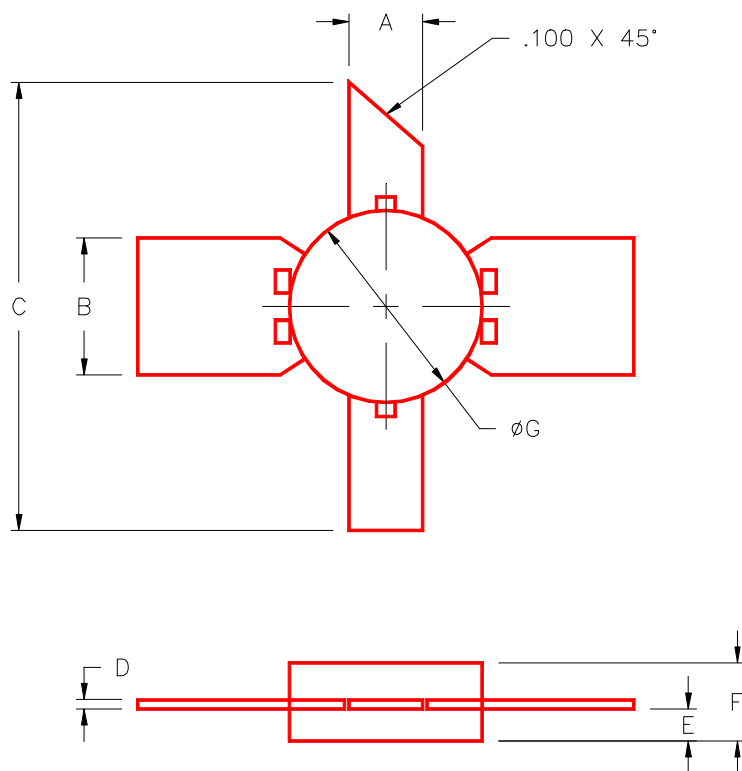
DYNAMIC

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
P_{OUT}	f =1025 - 1150 MHz P _{IN} = 400mW V _{CE} =35V	4	---	---	W
G_p	f =1025 - 1150 MHz P _{IN} = 400mW V _{CE} =35V	10	---	---	dB

Conditions: Pulse Width = 10 μs Duty Cycle = 1%

PACKAGE MECHANICAL DATA

PACKAGE STYLE M115



	MINIMUM INCHES/MM	MAXIMUM INCHES/MM		MINIMUM INCHES/MM	MAXIMUM INCHES/MM
A	.095/2,41	.105/2,67			
B	.195/4,95	.205/5,21			
C	1.000/25,40				
D	.004/0,10	.007/0,18			
E	.050/1,27	.065/1,65			
F	.120/3,05	.135/3,43			
G	.275/6,99	.285/7,21			